

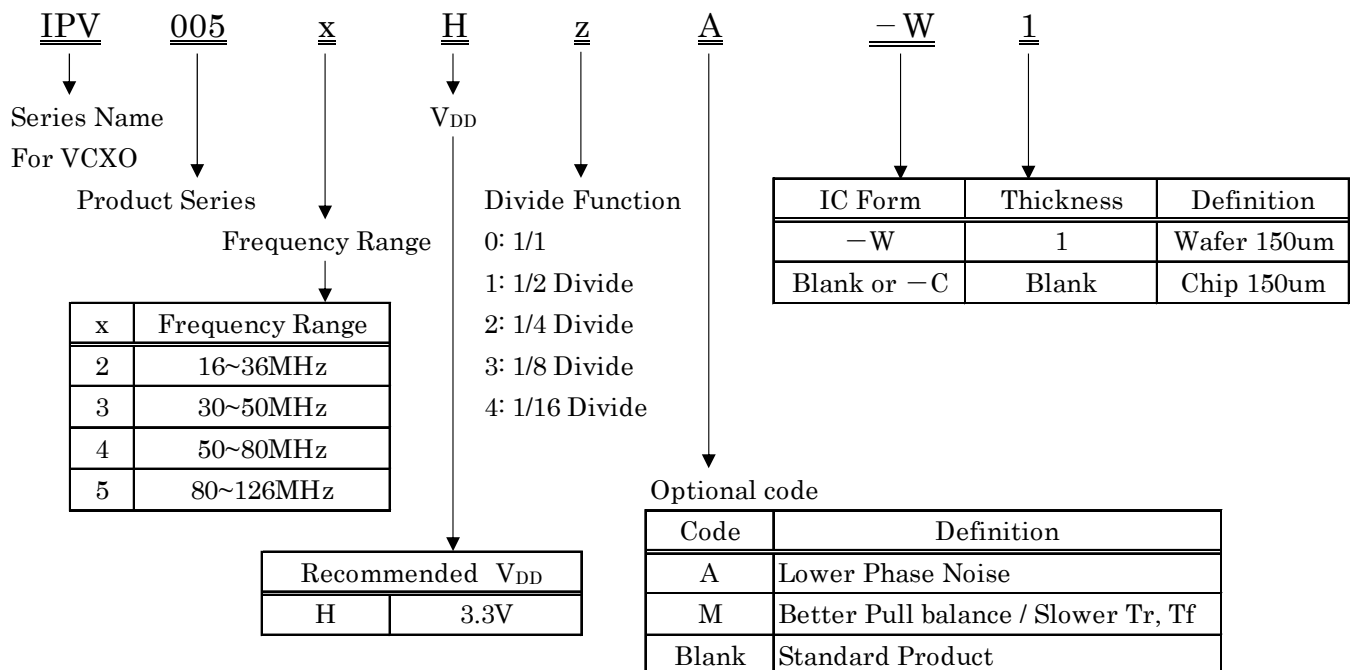
■ Description

IPV005xH Series IC is a single chip VCXO IC with built-in Variable Capacitor. This product has the features of the wide pulling range, the low power consumption and a stable output against voltage fluctuation by the built-in the original voltage variable capacitor and high precision constant voltage circuit. Also the small chip size of this product enables a smaller VCXO having output frequency from 1MHz to 126MHz.

■ Features

- Operation temperature : -40°C~125°C (Except IPV0055)
- Power supply voltage : 2.52V~3.63V
- Vc Input impedance : 5MΩ
- Standby function : Output disable
- Crystal frequency : 16MHz~126MHz
- Low power consumption : 3mA (IPV0052H)
- Output : CMOS
- Divide function : 1/2, 1/4, 1/8 and 1/16
- Small chip size : 0.75mm × 1.00mm
- Frequency stability to V_{DD} : Within ±1ppm
- Wide pulling range : ±100ppm minimum / Vc=1.65V±1.35V
- Duty cycle : Within 50%±5%

1. Part number rule



2. Series

Part Number	Crystal Frequency f (MHz)		Divide	Output Frequency FO (MHz)		Remarks
	Min.	Max.		Min.	Max.	
IPV005 2 H 0	16.00	36.00	1/1	16.00	36.00	
IPV005 2 H 1			1/2	8.00	18.00	
IPV005 2 H 2			1/4	4.00	9.00	
IPV005 2 H 3			1/8	2.00	4.50	
IPV005 2 H 4			1/16	1.00	2.25	
IPV005 3 H 0	30.00	50.00	1/1	30.00	50.00	
IPV005 3 H 1			1/2	15.00	25.00	
IPV005 3 H 2			1/4	7.50	12.50	
IPV005 4 H 0	50.00	80.00	1/1	50.00	80.00	Wider Frequency range than 54H0M
IPV005 4 H 1			1/2	25.00	40.00	
IPV005 4 H 0 M	45.00	60.00	1/1	45.00	60.00	Better Pull balance than 54H0
IPV005 5 H 0	80.00	126.00	1/1	80.00	126.00	
IPV005 5 H 0 M	80.00	126.00	1/1	80.00	126.00	Tr, Tf is Slower than 55H0
IPV005 5 H 0 A	80.00	126.00	1/1	80.00	126.00	Lower Phase Noise

3. Absolute Maximum Ratings
 $V_{SS}=0V, T_a=25^{\circ}C \pm 2^{\circ}C$

Parameter	Symbol	Condition	Ratings		
			Min	Max	Unit
Supply Voltage	V_{DD}		$V_{SS}-0.5$	7.0	V
Input Voltage	V_{IN}	All Input Pin	$V_{SS}-0.5$	$V_{DD}+0.5$	V
Output Voltage	V_{OUT}		$V_{SS}-0.5$	$V_{DD}+0.5$	V
Output Current	I_{OUT}			30	mA
Junction Temperature	T_j		-55	150	$^{\circ}C$
Storage Temperature	T_{stg}		-55	125	$^{\circ}C$

4. Recommended Operating Condition
 $V_{SS}=0V, T_a=-40^{\circ}C\sim 125^{\circ}C$ (85°C with IPV0055)

Parameter	Symbol	Condition	Min	Typ	Max	Unit	Note
Supply Voltage	V_{DD}		2.52	3.30	3.63	V	V_{DD}
“H” Input Voltage	V_{IH}		$V_{DD}\times 0.7$			V	OE
“L” Input Voltage	V_{IL}				$V_{DD}\times 0.3$	V	OE
Input Voltage	V_{IN}		V_{SS}		V_{DD}	V	OE
Control Voltage	V_C		0		$V_{DD} + 1.0$	V	VC
Output Load Capacitance	IPV0052H	CL	CMOS	15	30	pF	OUT
	Others				15		
Ambient Temperature 1	T_{opt}	Except IPV0055	-40		125	°C	
Ambient Temperature 2	T_{opt}	IPV0055	-40		85	°C	

This IC has enough immunity against ESD and Latch-up, but handle with care.

5. Electrical Specification
 5-1 IPV0052Hz, 53Hz, 54Hz

 Unless otherwise stated, $V_{DD}=2.52V\sim 3.63V$, $V_{SS}=0V$, $T_a=-40^{\circ}C\sim 125^{\circ}C$

Parameter	Symbol	Condition	Specification			Unit	
			Min	Typ	Max		
“H” input current	I_{IH}	$V_{IN}=V_{DD}$			1.0	μA	
“L” input current	I_{IL}	$V_{IN}=V_{SS}$		1.3	10	μA	
“H” output voltage	V_{OH}	$I_{OH}=-5mA, -40^{\circ}C\sim 85^{\circ}C$ $I_{OH}=-3mA, 85^{\circ}C\sim 125^{\circ}C$	V_{DD} -0.4			V	
“L” output voltage	V_{OL}	$I_{OL}=5mA, -40^{\circ}C\sim 85^{\circ}C$ $I_{OL}=3mA, 85^{\circ}C\sim 125^{\circ}C$			0.4	V	
Current consumption	I_{DD}	$CL=15pF, V_{DD}=3.63V$ $OE\geq V_{DD}-0.3V, f=27MHz$		3.0	5.0	mA	
Current consumption at output disable	I_{DDD}	$CL=15pF, V_{DD}=3.63V$ $OE\leq 0.3V, f=27MHz$		1.0	2.0	mA	
Output off leak at output disable	I_o	$OE\leq 0.3V$			10	μA	
Output Duty Ratio	Duty	$CL=15pF$ $f=27MHz$ $V_c=1/2V_{DD}$	-40 $^{\circ}C\sim 85^{\circ}C$	45	55	%	
			85 $^{\circ}C\sim 125^{\circ}C$	43	57		
Pull Range	Fentr	$V_c=+1.65\pm 1.35V, 27MHz$ Crystal *1	± 110			ppm	
Rise time	Tr	$CL=15pF, 10\sim 90\% V_{DD}$	-40 $^{\circ}C\sim 85^{\circ}C$		3.0	4.5	ns
					85 $^{\circ}C\sim 125^{\circ}C$		
			-40 $^{\circ}C\sim 85^{\circ}C$		2.5	3.5	
					85 $^{\circ}C\sim 125^{\circ}C$		
			-40 $^{\circ}C\sim 85^{\circ}C$		2.0	3.0	
					85 $^{\circ}C\sim 125^{\circ}C$		
Fall time	Tf	$CL=15pF, 90\sim 10\% V_{DD}$	-40 $^{\circ}C\sim 85^{\circ}C$		3.0	4.5	ns
					85 $^{\circ}C\sim 125^{\circ}C$		
			-40 $^{\circ}C\sim 85^{\circ}C$		2.5	3.5	
					85 $^{\circ}C\sim 125^{\circ}C$		
			-40 $^{\circ}C\sim 85^{\circ}C$		2.0	3.0	
					85 $^{\circ}C\sim 125^{\circ}C$		
Output Enable Time	Tpe				100	ns	
Output Disable Time	Tpd				100	ns	
Modulation Band Width	Fc	$V_c=1.35\sin\omega t+1.65V$	15	20		kHz	

 Crystal *1 ; Equivalent Parameter of Crystal is $\gamma=C0/C1<300$

5-2 IPV0054H0M

 Unless otherwise stated, $V_{DD}=2.52V\sim 3.63V$, $V_{SS}=0V$, $T_a=-40^{\circ}C\sim 85^{\circ}C$

Parameter	Symbol	Condition	Specification			Unit
			Min	Typ	Max	
“H” input current	I_{IH}	$V_{IN}=V_{DD}$			1.0	μA
“L” input current	I_{IL}	$V_{IN}=V_{SS}$			10	μA
“H” output voltage	V_{OH}	$I_{OH}=-5mA$	$V_{DD}-0.4$			V
“L” output voltage	V_{OL}	$I_{OL}=5mA$			0.4	V
Current consumption	I_{DD}	$CL=15pF$, $V_{DD}=3.63V$ $OE\geq V_{DD}-0.3V$, $f=54MHz$		6.0	10.0	mA
Current consumption at output disable	I_{DDD}	$CL=15pF$, $V_{DD}=3.63V$ $OE\leq 0.3V$, $f=54MHz$		2.0	3.0	mA
Output off leak at output disable	I_o	$OE\leq 0.3V$			10	μA
Output Duty Ratio	Duty	$CL=15pF$, $f=54MHz$, $V_c=1/2V_{DD}$	45		55	%
Pull Range	Fentr	$V_c=+1.65\pm 1.35V$, 54MHz Crystal ^{*1}	± 110			ppm
Rise time	T_r	$CL=15pF$, 10~90% V_{DD}		2.0	3.0	ns
Fall time	T_f	$CL=15pF$, 90~10% V_{DD}		2.0	3.0	ns
Output Enable Time	T_{pe}				100	ns
Output Disable Time	T_{pd}				100	ns
Modulation Band Width	F_c	$V_c=1.35\sin\omega t+1.65V$	15	20		kHz

 Crystal ^{*1} ; Equivalent Parameter of Crystal is $\gamma=C0/C1<300$

5-3 IPV0055H0

 Unless otherwise stated, $V_{DD}=2.52V\sim 3.63V$, $V_{SS}=0V$, $T_a=-40^{\circ}C\sim 85^{\circ}C$

Parameter	Symbol	Condition	Specification			Unit
			Min	Typ	Max	
“H” input current	I_{IH}	$V_{IN}=V_{DD}$			1.0	μA
“L” input current	I_{IL}	$V_{IN}=V_{SS}$			100	μA
“H” output voltage	V_{OH}	$I_{OH}=-5mA$	$V_{DD}-0.4$			V
“L” output voltage	V_{OL}	$I_{OL}=5mA$			0.4	V
Current consumption	I_{DD}	$CL=15pF$, $V_{DD}=3.63V$ $OE \geq V_{DD}-0.3V$, $f=126MHz$		16.0	20.0	mA
Current consumption at output disable	I_{DDD}	$CL=15pF$, $V_{DD}=3.63V$ $OE \leq 0.3V$, $f=126MHz$		8.6	10.0	mA
Output off leak at output disable	I_o	$OE \leq 0.3V$			10	μA
Output Duty Ratio	Duty	$CL=15pF$ $V_c=1/2V_{DD}$	$f=80MHz$	45	55	%
			$f=100MHz$	45	55	%
			$f=126MHz$	40	60	%
Pull Range	F_{entr}	$V_c=1.65 \pm 1.65V$ Crystal ^{*1}	$f=80MHz$	± 110		ppm
			$f=100MHz$	± 100		ppm
			$f=126MHz$	± 90		ppm
Rise time	T_r	$CL=15pF$, 10~90% V_{DD}		1.5	1.9	ns
Fall time	T_f	$CL=15pF$, 90~10% V_{DD}		1.4	1.9	ns
Output Enable Time	T_{pe}				100	ns
Output Disable Time	T_{pd}				100	ns
Modulation Band Width	F_c	$V_c=1.35\sin\omega t+1.65V$	15			kHz

 Crystal ^{*1} ; Equivalent Parameter of Crystal is $\gamma=C0/C1<300$

5-4 IPV0055H0M

 Unless otherwise stated, $V_{DD}=2.52V\sim 3.63V$, $V_{SS}=0V$, $T_a=-40^{\circ}C\sim 85^{\circ}C$

Parameter	Symbol	Condition	Specification			Unit
			Min	Typ	Max	
“H” input current	I_{IH}	$V_{IN}=V_{DD}$			1.0	μA
“L” input current	I_{IL}	$V_{IN}=V_{SS}$			100	μA
“H” output voltage	V_{OH}	$I_{OH}=-5mA$	$V_{DD}-0.4$			V
“L” output voltage	V_{OL}	$I_{OL}=5mA$			0.4	V
Current consumption	I_{DD}	$CL=15pF$, $V_{DD}=3.63V$ $OE \geq V_{DD}-0.3V$, $f=126MHz$		16.0	20.0	mA
Current consumption at output disable	I_{DDD}	$CL=15pF$, $V_{DD}=3.63V$ $OE \leq 0.3V$, $f=126MHz$		8.6	10.0	mA
Output off leak at output disable	I_o	$OE \leq 0.3V$			10	μA
Output Duty Ratio	Duty	$CL=15pF$ $V_c=1/2V_{DD}$	$f=80MHz$	45	55	%
			$f=100MHz$	45	55	%
			$f=126MHz$	40	60	%
Pull Range	F_{entr}	$V_c=1.65 \pm 1.35V$ Crystal ^{*1}	$f=80MHz$	± 110		ppm
			$f=100MHz$	± 100		ppm
			$f=126MHz$	± 90		ppm
Rise time	T_r	$CL=15pF$, 10~90% V_{DD}		2.5	4.0	ns
Fall time	T_f	$CL=15pF$, 90~10% V_{DD}		2.0	3.5	ns
Output Enable Time	T_{pe}				100	ns
Output Disable Time	T_{pd}				100	ns
Modulation Band Width	F_c	$V_c=1.35\sin\omega t+1.65V$	15			kHz

 Crystal ^{*1} ; Equivalent Parameter of Crystal is $\gamma=C0/C1<300$

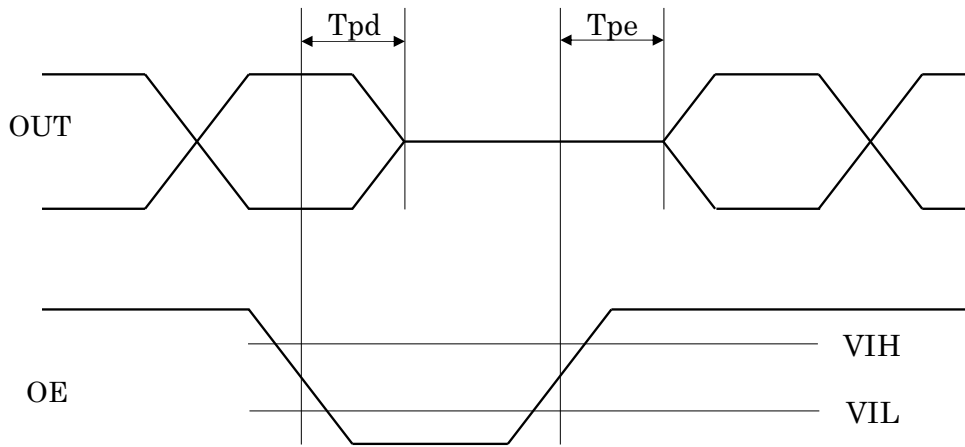
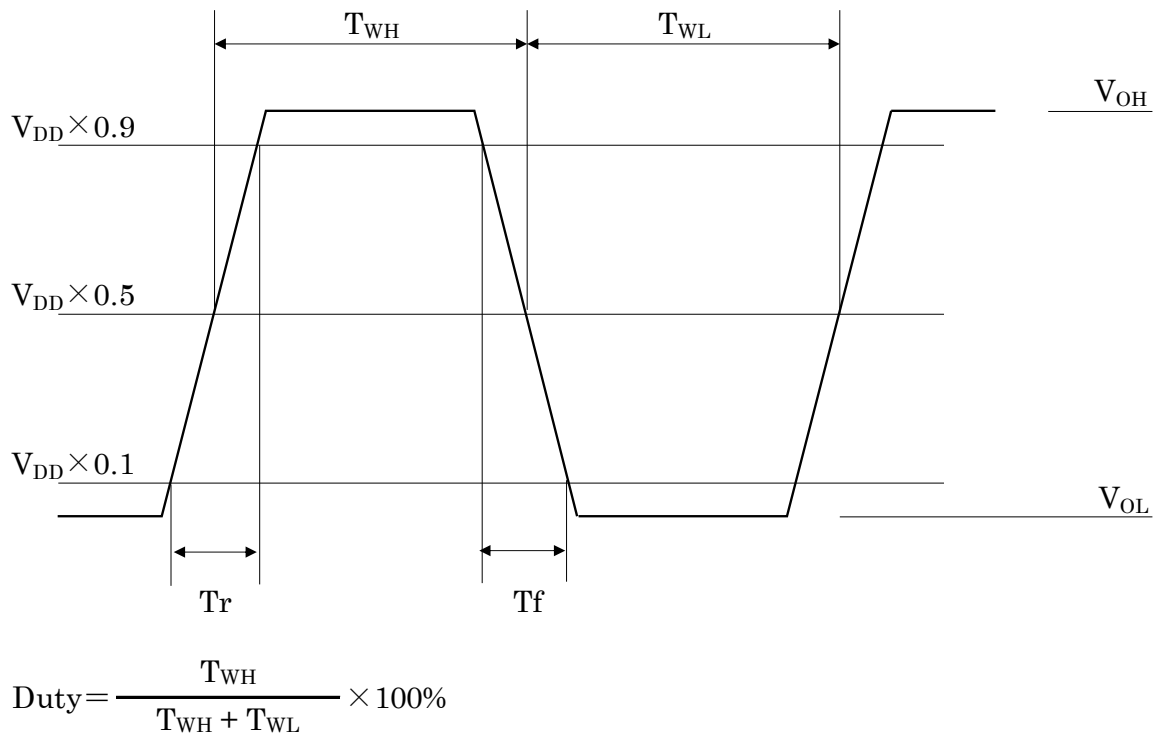
5-5 IPV0055H0A

 Unless otherwise stated, $V_{DD}=2.52V\sim 3.63V$, $V_{SS}=0V$, $T_a=-40^{\circ}C\sim 85^{\circ}C$

Parameter	Symbol	Condition	Specification			Unit
			Min	Typ	Max	
“H” input current	I_{IH}	$V_{IN}=V_{DD}$			1.0	μA
“L” input current	I_{IL}	$V_{IN}=V_{SS}$			100	μA
“H” output voltage	V_{OH}	$I_{OH}=-5mA$	$V_{DD}-0.4$			V
“L” output voltage	V_{OL}	$I_{OL}=5mA$			0.4	V
Current consumption	I_{DD}	$CL=15pF$, $V_{DD}=3.63V$ $OE\geq V_{DD}-0.3V$, $f=126MHz$		16.0	20.0	mA
Current consumption at output disable	I_{DDD}	$CL=15pF$, $V_{DD}=3.63V$ $OE\leq 0.3V$, $f=126MHz$		8.6	10.0	mA
Output off leak at output disable	I_o	$OE\leq 0.3V$			10	μA
Output Duty Ratio	Duty	$CL=15pF$ $V_c=1/2V_{DD}$	$f=80MHz$	45	55	%
			$f=100MHz$	45	55	%
			$f=126MHz$	40	60	%
Pull Range	F_{entr}	$V_c=1.65\pm 1.65V$ Crystal *1	$f=80MHz$	± 110		ppm
			$f=100MHz$	± 100		ppm
			$f=126MHz$	± 90		ppm
Rise time	T_r	$CL=15pF$, 10~90% V_{DD}		1.5	1.9	ns
Fall time	T_f	$CL=15pF$, 90~10% V_{DD}		1.4	1.9	ns
Output Enable Time	T_{pe}				100	ns
Output Disable Time	T_{pd}				100	ns
Modulation Band Width	F_c	$V_c=1.35\sin\omega t+1.65V$	15			kHz

 Crystal *1 ; Equivalent Parameter of Crystal is $\gamma=C0/C1<300$
Phase Noise comparison
 $F_0=122MHz$, $V_c=1.65V$, Room Temperature

Offset	IPV0055H0	IPV0055H0A
10Hz	-69 dBc/Hz	-70 dBc/Hz
100Hz	-101 dBc/Hz	-103 dBc/Hz
1kHz	-126 dBc/Hz	-127 dBc/Hz
10kHz	-140 dBc/Hz	-145 dBc/Hz
100kHz	-154 dBc/Hz	-156 dBc/Hz
1MHz	-160 dBc/Hz	-161 dBc/Hz
10MHz	-162 dBc/Hz	-162 dBc/Hz
Phase Jitter 12kHz~20MHz	71 fs	66 fs



V_{IH} : Threshold voltage for Output Start
 V_{IL} : Threshold voltage for Output Stop

Fig. 5-1 Output Wave Form (Duty, T_r , T_f , T_{pd} , T_{pe})

6. Circuit Parameters of Oscillator (Reference Data for Circuit Design)
 $V_{DD}=3.3V, V_{SS}=0V, T_a=25^{\circ}C, V_c=V_{SS}\sim V_{DD}$

Parameter		Symbol	Condition	Min	Typ	Max	Unit
Feedback Resistor		Rf		80	100	120	k Ω
Driving Resistor	IPV0052H	Rd	Refer to Fig. 6-1	0.95	1.20	1.45	k Ω
	IPV0053H			0.50	0.60	0.70	
	IPV0054H			0.08	0.10	0.12	
	IPV0054H0M			0.24	0.30	0.36	
	IPV0055H0, H0A			0.40	0.50	0.60	
	IPV0055H0M			0.08	0.10	0.12	
Bias Resistor		Rv1		200	240	280	k Ω
		Rv2		96	120	145	k Ω
Input Resistor		Rvc			20		k Ω
VC Input impedance		Zvc	VC terminal to GND	5			M Ω
Equivalent series (Loading) Capacitance	IPV0052H f=27MHz	CLxtal	Vc=0V		10.7		pF
			Vc=1.65V, 1.4V		6.0		
			Vc=3.3V, 3.0V		3.7		
	IPV0053H f=47MHz		Vc=0V		10.7		
			Vc=1.65V, 1.4V		6.0		
			Vc=3.3V, 3.0V		3.7		
	IPV0054H f=60MHz		Vc=0V		7.5		
			Vc=1.65V		3.0		
			Vc=3.3V		2.3		
	IPV0055H0, H0A f=120MHz		Vc=0V		4.5		
			Vc=1.65V		2.2		
			Vc=3.3V		1.5		
Drive Level	IPV0054H0M	DL	Vc=0V		240		μ W
			Vc=1.65V		200		
			Vc=3.3V		160		
	IPV0055H		Vc=0V		410		
			Vc=1.65V		390		
Vc=3.3V		320					
Frequency deviation by IC		$\Delta f_c/f_c$	Crystal fixed			25	ppm
DC cut Capacitor	All series except below.	Cpg		13	16	19	pF
		Cpd		40	50	60	
	IPV0055H0, H0A	Cpg		10	12	14	
		Cpd		38	48	58	
	IPV0055H0M	Cpg		10	12	14	
		Cpd		40	50	60	

*The above values are the design values and are not guaranteed by test.

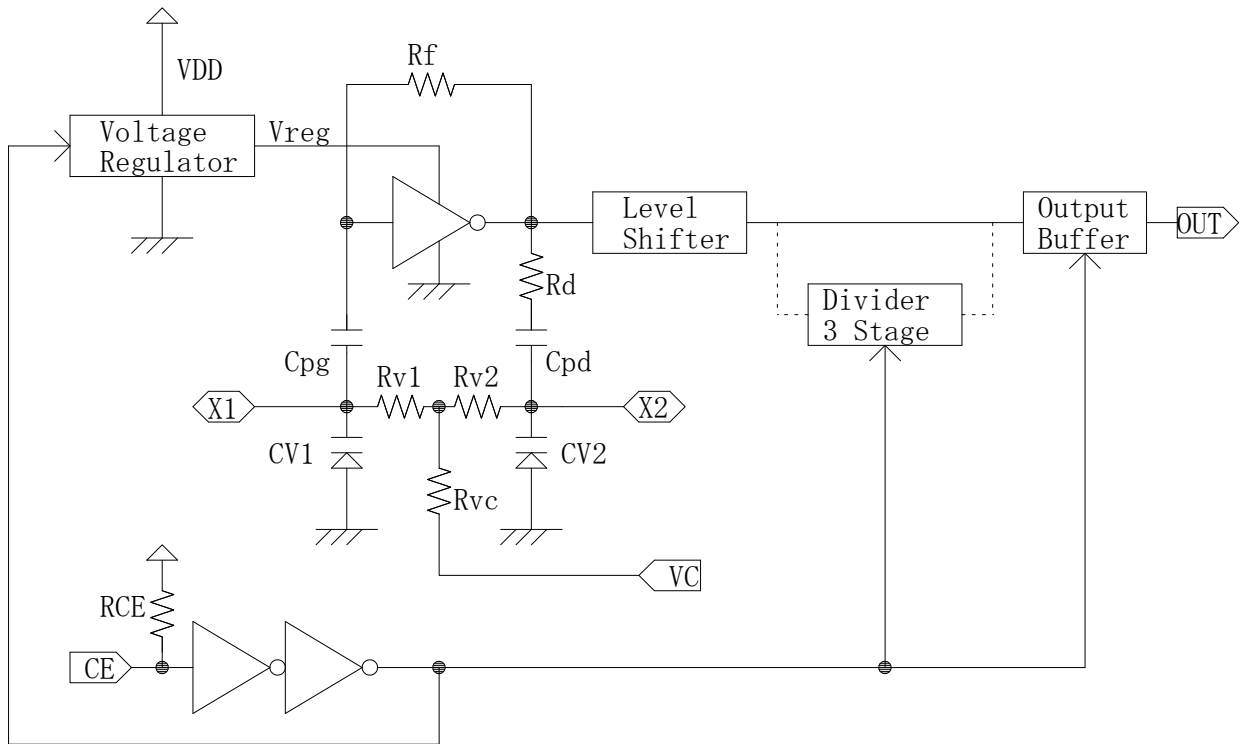
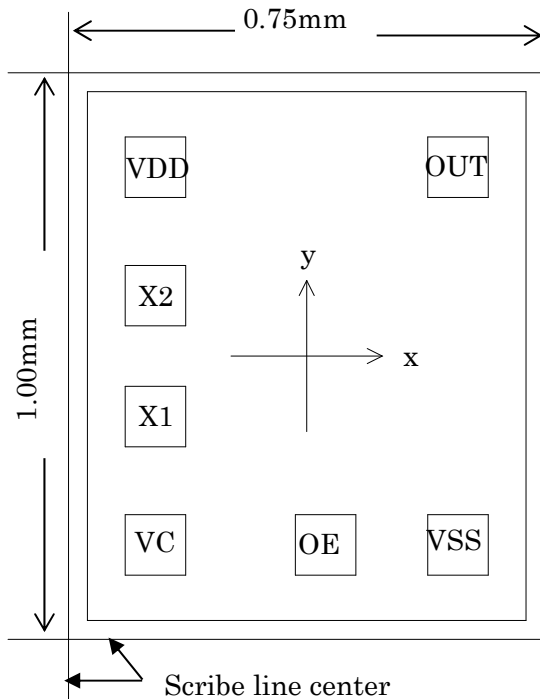


Fig. 6-1 Block Diagram

7. Pad Layout



- Die Size: 0.75mm × 1.00mm
- Pad Size: 80um □
- Thickness: 150um±20um
- IC Backside: Gnd or Open

Pad Name	Function	Location (μm)	
		x	y
VC	Frequency Control Input	-244	-359
OE	Output Enable, "L": High-Impedance *1)	44	-359
VSS	(-) Ground	244	-359
OUT(Q)	Frequency Output	179	359
VDD	(+) Power Supply	-244	359
X2	Crystal Drive	-244	132
X1	Crystal Feedback	-244	-132
Chip Center		0	0

*1) : 2.5MΩ Typ.